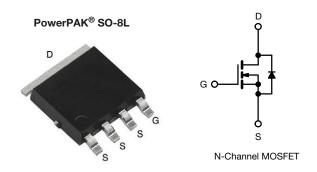
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	65	50		
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.208		
Q _g max. (nC)	2	3		
Q _{gs} (nC)	4			
Q _{gd} (nC)	6			
Configuration	Sin	Single		

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiHJ240N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600	V	
Gate-source voltage			V_{GS}	± 30	V	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	- I _D	12	A	
	VGS at 10 V	T _C = 100 °C		7		
Pulsed drain current ^a			I _{DM}	30	1	
Linear derating factor				0.63	W/°C	
Single pulse avalanche energy b			E _{AS}	81	mJ	
Maximum power dissipation			P _D	89	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope		T _J = 125 °C	dv/dt	70 V/ns		
Reverse diode dv/dt ^c		uv/dt	28	V/IIS		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.4 A
- c. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting $T_J = 25$ °C



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	52	65	°C/W		
Maximum junction-to-case (drain)	R _{thJC}	1.0	1.4			

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		-	5.0	V
Cata assuma lagicara		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
Zoro goto voltago drain ourrent	la a a	V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 5.5 A	-	0.208	0.240	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} = 20 V, I _D = 5.5 A		=.	4	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	783	-	pF
Output capacitance	C_{oss}			=.	50	-	
Reverse transfer capacitance	C _{rss}			-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	32	-	
Effective output capacitance, time related ^b	$C_{o(tr)}$			-	187	-	
Total gate charge	Qg				15	23	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 5.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	4	-	nC
Gate-drain charge	Q_{gd}			-	6	-	
Turn-on delay time	t _{d(on)}			1	15	30	
Rise time	t _r		$V_{DD} = 480 \text{ V}, I_D = 5.5 \text{ A},$		14	28	ne
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		-	26	52	ns
Fall time	t _f			ı	14	28	
Gate input resistance	R_g	f = 1 MHz, open drain		0.8	1.5	3.0	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	12	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	30	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 5.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}				209	418	ns
Reverse recovery charge	Q _{rr}	$T_J = 25$ °C, $I_F = I_S = 5.5$ A, di/dt = 100 A/ μ s, $V_R = 25$ V		-	2.1	4.2	μC
Reverse recovery current	I _{RRM}			_	18	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

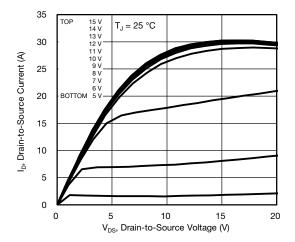


Fig. 1 - Typical Output Characteristics

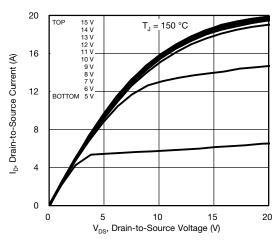


Fig. 2 - Typical Output Characteristics

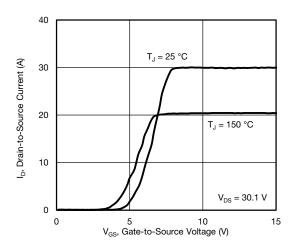


Fig. 3 - Typical Transfer Characteristics

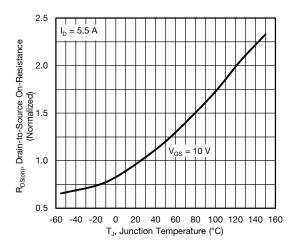


Fig. 4 - Normalized On-Resistance vs. Temperature

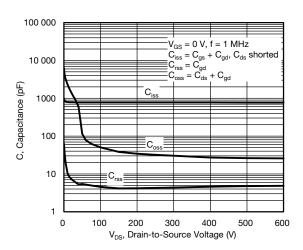


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

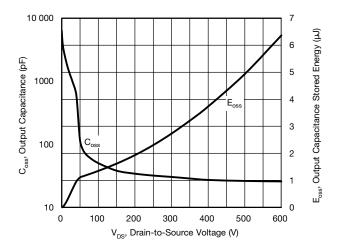


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



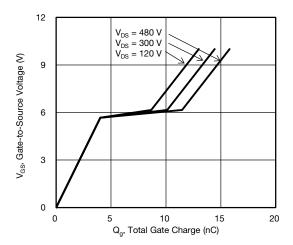


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

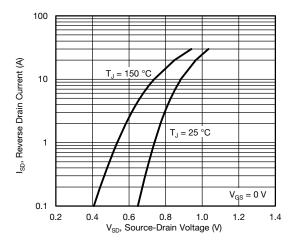


Fig. 8 - Typical Source-Drain Diode Forward Voltage

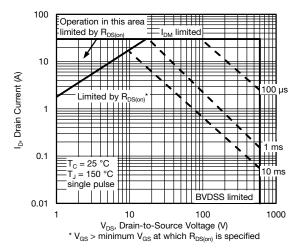


Fig. 9 - Maximum Safe Operating Area

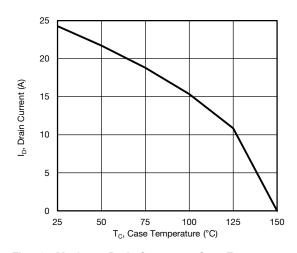


Fig. 10 - Maximum Drain Current vs. Case Temperature

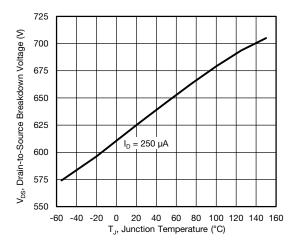


Fig. 11 - Temperature vs. Drain-to-Source Voltage



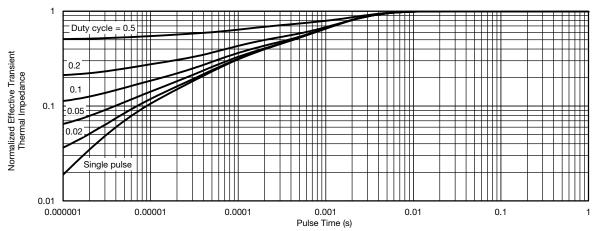


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

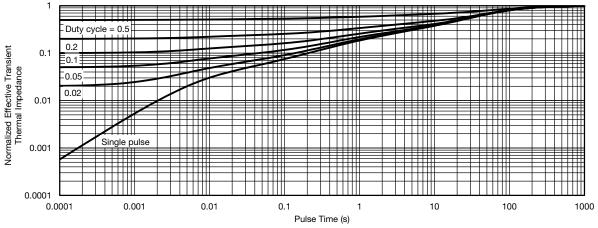


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

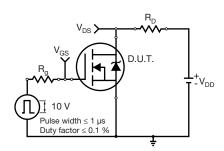


Fig. 14 - Switching Time Test Circuit

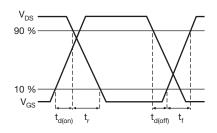


Fig. 15 - Switching Time Waveforms

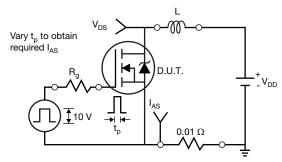


Fig. 16 - Unclamped Inductive Test Circuit

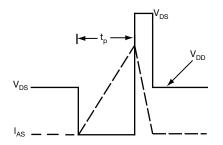


Fig. 17 - Unclamped Inductive Waveforms



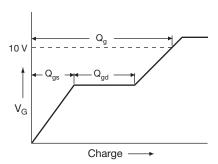


Fig. 18 - Basic Gate Charge Waveform

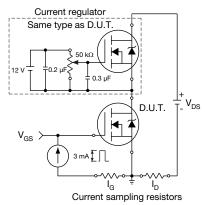
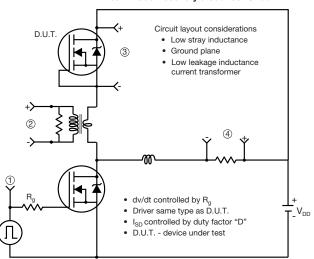


Fig. 19 - Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



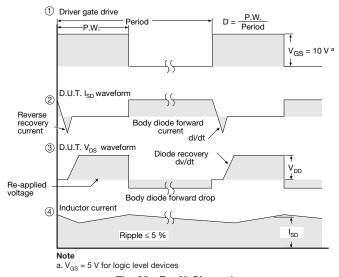


Fig. 20 - For N-Channel

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